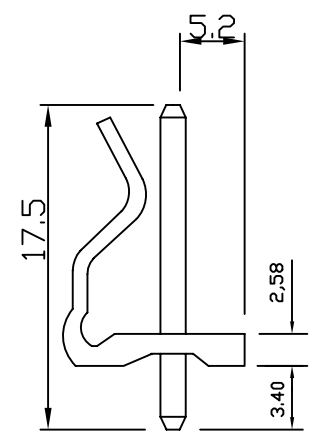
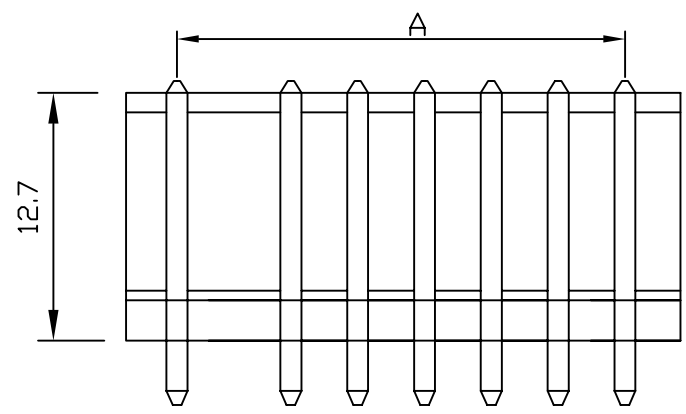


750G3-VXX Series Wafer

Material: Nylon 66 UL 94V-0
 Pin Beass Tin-Plated
 Mate with 750G3-HXX Housing
 Current rating: 7A AC, DC
 Voltage rating: 250V AC, DC
 Contact resistance: Max 20m
 Insulation resistance: 1000M?Min
 Withstanding voltage: 1500V AC/Minute
 Temperature range: -25? TO +85?
 SQ Pin size: 1.14mm
 PC Board hole: 1.65mm Dia
 PC Board thickness: 1.6mm



DIM	POS	2	3	4	5	6	7
A		12.50	17.50	22.50	27.50	32.50	37.5
B		7.50	12.50	17.50	22.50	27.50	32.5

Rev	Dexcription/Date	Drawn By: Storm.li	Customer:	Third angle projection			X.± .X±0.30 .XX±0.20 .XXX±0.10
△		Checked By: Simmon	Part No.: 750G3-VXX	Genral Dimension Tolerance			
△		Approved By: Tony	Title: 7.5mm/5.0mm pitch Wire to Board Wafer				
SGS Report No.:							